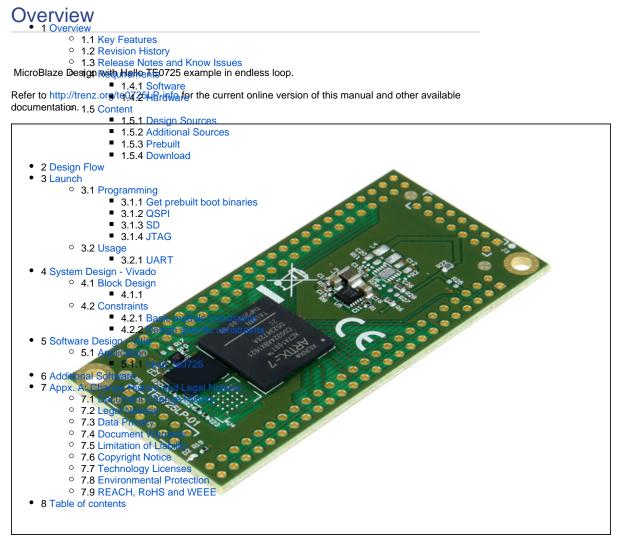
# **TE0725LP Test Board**

## Table of contents



## **Key Features**

- Vitis/Vivado 2021.2
- MicroBlaze
- QSPI
- I2C
- UART

## **Revision History**

Date	Vivado	Project Built	Authors	Description
2022-08-31	2021.2	TE0725LP- test_board_noprebui It-vivado_2021.2- build_15_20220831 152107.zip TE0725LP- test_board- vivado_2021.2- build_15_20220831 152107.zip	Waldemar Hanemann	<ul> <li>2021.2 update</li> <li>Documentation style update</li> </ul>
2020-04-20	2019.2	TE0725LP- test_board_noprebui lt-vivado_2019.2- build_10_20200420 093012.zip TE0725LP- test_board- vivado_2019.2- build_10_20200420 092959.zip	John Hartfiel	• 2019.2 update
2019-11-19	2018.2	TE0725LP- test_board_noprebui It-vivado_2018.2- build_04_20191119 080754.zip TE0725LP- test_board- vivado_2018.2- build_04_20191119 080742.zip	John Hartfiel	<ul> <li>bugfix board part files clk settings</li> </ul>
2018-08-16	2018.2	TE0725LP- test_board- vivado_2018.2- build_02_20180816 093341.zip TE0725LP- test_board_noprebui It-vivado_2018.2- build_02_20180816 093354.zip	John Hartfiel	• 2018.2 update
2018-03-19	2017.4	TE0725LP- test_board- vivado_2017.4- build_07_20180319 162005.zip TE0725LP- test_board_noprebui It-vivado_2017.4- build_07_20180319 162259.zip	John Hartfiel	• initial release

Design Revision History

# **Release Notes and Know Issues**

Issues	Description	Workaround	To be fixed version
No known issues			
Known lesues			

Known Issues

# Requirements

### Software

Software	Versio	n Note
Vitis	2021.2	needed, Vivado is included into Vitis installation

Software

#### Hardware

Basic description of TE Board Part Files is available on TE Board Part Files.

Complete List is available on <design name>/board\_files/\*\_board\_files.csv

Design supports following modules:

Module Model	Board Part Short Name	PCB Revision Support	DDR	QSPI Flash	ЕММС	Others	Notes
TE0725LP- 01-100-2C	100	REV01	NA	32MB	NA	NA	3.3V Input Voltage
TE0725LP- 01-100-2D	100	REV01	NA	32MB	NA	NA	1.8V Input Voltage
TE0725LP- 01-100-2L	100	REV01	NA	32MB	NA	NA	1.8V Input Voltage
TE0725LP- 01-100-2I	100_2i	REV01	NA	32MB	NA	NA	1.8V Input Voltage
TE0725LP- 01-72C-1	100	REV01	NA	32MB	NA	NA	3.3V Input Voltage
TE0725LP- 01-72C-1T	100	REV01	NA	32MB	NA	NA	1.8V Input Voltage
TE0725LP- 01-72I-1T	100_2i	REV01	NA	32MB	NA	NA	1.8V Input Voltage
TE0725LP- 01-72C-1U	100	REV01	NA	32MB	NA	NA	1.8V Input Voltage
TE0725LP- 01-72C-1H	100	REV01	NA	32MB	NA	with hyperflash	3.3V Input Voltage

#### Hardware Modules

Design supports following carriers:

Carrier Model	Notes
Hardware Carrier	

Additional HW Requirements:

Additional Hardware	Notes
TE0790 JTAG Programmer	Important: Depending on assembly version, it's not possible to supply module via TE0790. If it's possible, it's not recommended to use TE0790 for power supply( TE0790 TRM#PowerandPower- OnSequence)
External power supply	3.3V or 1.8V depending on assembly variant
Additional Hardware	

Additional Hardware

## Content

For general structure and of the reference design, see Project Delivery - AMD devices

### **Design Sources**

Туре	Location	Notes
Vivado	<design name="">/block_design <design name="">/constraints <design name="">/ip_lib</design></design></design>	Vivado Project will be generated by TE Scripts
Vitis	<design name="">/sw_lib</design>	Additional Software Template for Vitis and apps_list.csv with settings automatically for Vitis app generation

#### **Design sources**

#### **Additional Sources**

Туре	Location	Notes

Additional design sources

#### Prebuilt

File	File-Extension	Description
BIT-File	*.bit	FPGA (PL Part) Configuration File
DebugProbes-File	*.ltx	Definition File for Vivado/Vivado Labtools Debugging Interface
Diverse Reports		Report files in different formats
Hardware-Platform- Specification-Files	*.xsa	Exported Vivado Hardware Specification for Vitis and PetaLinux
LabTools Project-File	*.lpr	Vivado Labtools Project File
MCS-File	*.mcs	Flash Configuration File with Boot-Image (MicroBlaze or FPGA part only)
MMI-File	*.mmi	File with BRAM-Location to generate MCS or BIT-File with *. elf content (MicroBlaze only)
Software-Application-File	*.elf	Software Application for Zynq or MicroBlaze Processor Systems

Prebuilt files (only on ZIP with prebult content)

### Download

Reference Design is only usable with the specified Vivado/Vitis/PetaLinux version. Do never use different Versions of Xilinx Software for the same Project.

Reference Design is available on:

• TE0725LP "Test Board" Reference Design

## **Design Flow**

A Reference Design is available with and without prebuilt files. It's recommended to use TE prebuilt files for first lunch.

Trenz Electronic provides a tcl based built environment based on Xilinx Design Flow.

See also:

- AMD Development Tools#XilinxSoftware-BasicUserGuides
- Vivado Projects TE Reference Design
- Project Delivery.

The Trenz Electronic FPGA Reference Designs are TCL-script based project. Command files for execution will be generated with "\_create\_win\_setup.cmd" on Windows OS and "\_create\_linux\_setup.sh" on Linux OS.

TE Scripts are only needed to generate the vivado project, all other additional steps are optional and can also executed by Xilinx Vivado/Vitis GUI. For currently Scripts limitations on Win and Linux OS see: Proje ct Delivery Currently limitations of functionality

Caution! Win OS has a 260 character limit for path lengths which can affect the Vivado tools.
 To avoid this issue, use Virtual Drive or the shortest possible names and directory locations
 for the reference design (for example "x:\<project folder>")

1. Run \_create\_win\_setup.cmd/\_create\_linux\_setup.sh and follow instructions on shell:

_create_win_setup.cmd/_create_linux_setup.sh
Run Design with: _create_win_setup Use Design Path: <absolute path="" project=""></absolute>
TE Reference
Design
(0) Module selection guide, project creationprebuilt export
(1) Create minimum setup of CMD-Files and exit Batch
(2) Create maximum setup of CMD-Files and exit Batch
(3) (internal only) Dev
(4) (internal only) Prod
(c) Go to CMD-File Generation (Manual setup)
(d) Go to Documentation (Web Documentation)
(g) Install Board Files from Xilinx Board Store (beta)
(a) Start design with unsupported Vivado Version (beta)
(x) Exit Batch (nothing is done!)
Select (ex.:'0' for module selection guide):

- Press 0 and enter to start "Module Selection Guide"
   Create project and follow instructions of the product selection guide, settings file will be
  - optional for manual changes: Select correct device and Xilinx install path on "design\_basic\_settings.cmd" and create Vivado project with "vivado\_create\_project\_guimode.cmd"

Note: Select correct one, see also Vivado Board Part Flow ≙

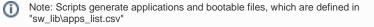
a. Create hardware description file (.xsa file) for PetaLinux project and export to prebuilt folder

run on Vivado TCL (Script generates design and export files into " <project folder="">\prebuilt\hardware\<short name="">")</short></project>		
TE::hw_build_design -export_prebuilt		
Using Vivado GUI is the same, except file export to prebuilt folder.		

4. Generate Programming Files with Vitis

run on Vivado TCL (Script generates applications and bootable files, which are			
defined in "test_board\sw_lib\apps_list.csv")			
TE::sw_run_vitis -all TE::sw_run_vitis (optional; Start Vitis from Vivado GUI or start with TE Scripts on Vivado TCL)			

**(**)



App from Firmware folder will be add into BlockRAM. If you add other app, you must select \*.elf

manually on Vivado

TCL scripts generate also platform project, this must be done manually in case GUI is used. See Vitis

5. (optional) Copy Application (hello\_te0725.elf) from prebuilt-folder into \firmware\microblaze\_0\ and regenerate design with

run on Vivado TCL (Script generates design and export files into "<project

folder>\prebuilt\hardware\<short name>")

TE::hw\_build\_design -export\_prebuilt

### Launch

∕₽

#### **Programming**

Check Module and Carrier TRMs for proper HW configuration before you try any design.

Xilinx documentation for programming and debugging: Vivado/SDK/SDSoC-Xilinx Software Programming and Debugging

#### Get prebuilt boot binaries

- 1. Run \_create\_win\_setup.cmd/\_create\_linux\_setup.sh and follow instructions on shell
- 2. Press 0 and enter to start "Module Selection Guide"
  - a. Select assembly version
  - b. Validate selection
  - c. Select create and open delivery binary folder

#### **QSPI**

- 1. Connect JTAG and power on carrier with module
- Open Vivado Project with "vivado\_open\_existing\_project\_guimode.cmd" or if not created, create with "vivado\_create\_project\_guimode.cmd"

Note: Folder "<project folder>\\_binaries\_<Article Name>" with subfolder "boot\_<app name>" for different applications will be generated

run on Vivado TCL (Script programs .mcs-File on QSPI flash)

```
TE::pr_program_flash -swapp hello_te0725
```

3. Press the reset button to start the application and see the output in the console

#### SD

Not used on this Example.

#### **JTAG**

- 1. Connect JTAG and power on PCB
- 2. Open Vivado HW Manager
- 3. Program FPGA with Bitfile from "prebuilt/hardware/<short dir>/"

### Usage

- 1. Prepare HW like described on section Programming
- 2. Connect UART USB (most cases same as JTAG)
- 3. 1. FPGA Loads Bitfile from Flash

3. Hello Trenz will be run on UART console.

info: Do not reboot, if Bitfile programming over JTAG is used as programming method.

#### a. UART

Open Serial Console (e.g. putty) Hello TE0725 will run on endless loop.

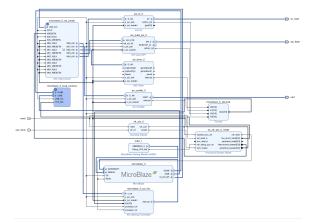
- i. Speed: 9600
- ii. COM Port: Win OS, see device manager, Linux OS see dmesg |grep tty (UART is \*USB1)

🛃 COM18 - PuTTY			
Hello	TE0725	(Loop:	10)
Hello	TE0725	(Loop:	11)
Hello	TE0725	(Loop:	12)
Hello	TE0725	(Loop:	13)
Hello	TE0725	(Loop:	14)
Hello	TE0725	(Loop:	15)
<b>Vollo</b>	TEOTOE	(Loop)	161

Power On PCB (Do not restart, if you use Bitfile programming)

# System Design - Vivado

#### **Block Design**



## **Constraints**

#### **Basic module constraints**

```
_i_bitgen_common.xdc
set_property BITSTREAM.GENERAL.COMPRESS TRUE [current_design]
set_property BITSTREAM.CONFIG.CONFIGRATE 66 [current_design]
set_property CONFIG_VOLTAGE 1.8 [current_design]
set_property CFGBVS GND [current_design]
set_property BITSTREAM.CONFIG.SPI_32BIT_ADDR YES [current_design]
set_property BITSTREAM.CONFIG.SPI_BUSWIDTH 4 [current_design]
set_property BITSTREAM.CONFIG.M1PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.M2PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.M0PIN PULLNONE [current_design]
set_property BITSTREAM.CONFIG.USR_ACCESS TIMESTAMP [current_design]
```

#### **Design specific constraints**

---

## Software Design - Vitis

For SDK project creation, follow instructions from:

Vitis

## Application

Template location: "<project folder>\sw\_lib\sw\_apps\"

#### hello\_te0725

Trenz Hello TE0725 example as endless loop. Output on console. Template location: \sw\_lib\sw\_apps\hello\_te0725 The printed Text can be modified.

## **Additional Software**

No additional software is needed.

# Appx. A: Change History and Legal Notices

### **Document Change History**

To get content of older revision got to "Change History" of this page and select older document revision number.

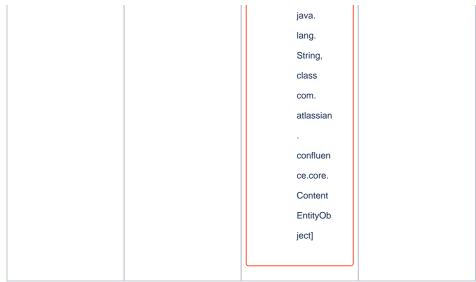
Date	Document Revision	Authors	Description
			<ul> <li>2021.2 update</li> <li>Documentation style update</li> </ul>
Error	Error	Error	
renderi	renderi	renderi	
ng	ng	ng	
macro	macro	macro	
'page-	'page-	'page-	
info'	info'	info'	
Ambiguo	Ambiguo	Ambiguo	
us	us	us	
method	method	method	
overload	overload	overload	
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method	method	method	
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proxy27	proxy27	proxy27	
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4022#ha	4022#ha	4022#ha	
sConten	sConten	sConten	
tLevelPe	tLevelPe	tLevelPe	

rmission	rmission	rmission
Cannot	Cannot	Cannot
resolve	resolve	resolve
which	which	which
method	method	method
to	to	to
invoke	invoke	invoke
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class	class	class
java.	java.	java.
lang.	lang.	lang.
String,	String,	String,
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confluen	confluen	confluen
ce.	ce.	ce.
pages.	pages.	pages.
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2020-04-20	v.9	John Hartfiel	<ul><li> 2019.2 release</li><li> docu update</li></ul>
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2019-11-19	v.8	John Hartfiel	<ul> <li>bugfix board part files</li> </ul>
2018-08-16	v.6	John Hartfiel	• 2018.2 release
2018-06-05	v.5	John Hartfiel	Typo correction     UART Speed

2018-03-19	v.3	John Hartfiel	• 2017.4 release
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		String,	
		class	
		com.	
		atlassian	

confluen ce. pages. Page] due to overlapp ing prototyp es between [interfac e com. atlassian confluen ce.user. Conflue nceUser , class java. lang. String, class com. atlassian confluen ce.core. Content EntityOb ject] [interfac e com. atlassian .user. User, class



Document change history.

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Error rendering macro 'page-info'

Ambiguous method overloading for method jdk.

proxy279.\$Proxy4022#hasContentLevelPermission. Cannot resolve which method to invoke for [null, class java.lang.String, class com.atlassian.confluence.pages.Page] due to overlapping prototypes between: [interface com.atlassian.confluence.user. ConfluenceUser, class java.lang.String, class com.atlassian.confluence.core. ContentEntityObject] [interface com.atlassian.user.User, class java.lang.String, class com.atlassian.confluence.core.ContentEntityObject]